

flowPACK 0 3rd gen
600V/75A
Features

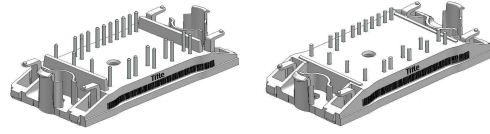
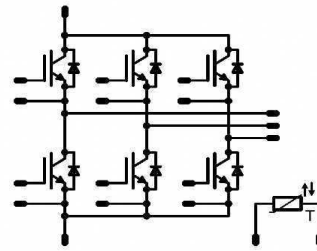
- 2 clip housing in 12mm and 17mm height
- Trench Fieldstop IGBT³ technology
- Compact and low inductance design
- Built-in NTC

Target Applications

- Motor Drives
- Power Generation
- UPS

Types

- V23990-P866-F49-PM: 17mm height
- V23990-P866-F48-PM: 12mm height

flow0 housing

Schematic


Maximum Ratings

 T_j=25°C, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Inverter Transistor				
Collector-emitter voltage	V _{CE}		600	V
DC collector current	I _C	T _j =T _{jmax} T _h =80°C T _c =80°C	58	A
Repetitive peak collector current	I _{Cpulse}	t _p limited by T _{jmax}	225	A
Power dissipation per IGBT	P _{tot}	T _j =T _{jmax} T _h =80°C T _c =80°C	90	W
Gate-emitter peak voltage	V _{GE}		±20	V
Short circuit ratings*	t _{SC}	T _j ≤150°C	6	µs
	V _{CC}	V _{GE} =15V	360	V
Maximum Junction Temperature	T _{jmax}		175	°C
Inverter Diode				
Peak Repetitive Reverse Voltage	V _{RRM}		600	V
DC forward current	I _F	T _j =T _{jmax} T _h =80°C T _c =80°C	50	A
Repetitive peak forward current	I _{FRM}	t _p limited by T _{jmax}	150	A
Power dissipation per Diode	P _{tot}	T _j =T _{jmax} T _h =80°C T _c =80°C	67	W
Maximum Junction Temperature	T _{jmax}		175	°C

Maximum Ratings

 T_j=25°C, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
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Thermal properties

Storage temperature	T _{stg}		-40.....+125	°C
Operation junction temperature	T _{op}		-40.....+T _{jmax} -25	°C

Insulation properties

Insulation voltage	V _{is}	t=2s DC voltage	4000	V
Creepage distance			min.12,7	mm
Clearance			min.12,7	mm

Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}[V]$ or $V_{GS}[V]$	$V_r[V]$ or $V_{CE}[V]$ or $V_{DS}[V]$	$I_c[A]$ or $I_F[A]$ or $I_D[A]$	T_j	Min	Typ	Max		
Inverter Transistor										
Gate emitter threshold voltage	$V_{GE(th)}$	VCE=VGE			0,0012	$T_j=25^{\circ}C$ $T_j=150^{\circ}C$	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		75	$T_j=25^{\circ}C$ $T_j=150^{\circ}C$	1,1	1,50 1,72	2,1	V
Collector-emitter cut-off current incl. Diode	I_{CES}		0	600		$T_j=25^{\circ}C$ $T_j=150^{\circ}C$			40	μA
Gate-emitter leakage current	I_{GES}		20	0		$T_j=25^{\circ}C$ $T_j=150^{\circ}C$			650	nA
Integrated Gate resistor	R_{gint}							none		Ω
Turn-on delay time	$t_{d(on)}$	Rgon=4 Ω Rgoff=4 Ω						$T_j=25^{\circ}C$	94,4	ns
Rise time	t_r							$T_j=150^{\circ}C$	94,4	
Turn-off delay time	$t_{d(off)}$							$T_j=25^{\circ}C$	11	
Fall time	t_f							$T_j=150^{\circ}C$	14,6	
Turn-on energy loss per pulse	E_{on}							$T_j=25^{\circ}C$	159	
Turn-off energy loss per pulse	E_{off}	$T_j=150^{\circ}C$	183							
Input capacitance	C_{ies}	f=1MHz	0	25			$T_j=25^{\circ}C$	$T_j=25^{\circ}C$	76	mWs
Output capacitance	C_{oss}							$T_j=150^{\circ}C$	95,8	
Reverse transfer capacitance	C_{rss}							$T_j=25^{\circ}C$	0,55	
Gate charge	Q_{Gate}		± 15	300	75	$T_j=25^{\circ}C$		470		nC
Thermal resistance chip to heatsink per chip	R_{thJH}	Thermal grease thickness $\leq 50\mu m$ $\lambda = 0,61 W/mK$							1,06	K/W
Inverter Diode										
Diode forward voltage	V_F				75	$T_j=25^{\circ}C$ $T_j=150^{\circ}C$	1,1	1,63 1,58	2,2	V
Peak reverse recovery current	I_{RRM}	Rgon=4 Ω	± 15	300	75			$T_j=25^{\circ}C$	101	A
Reverse recovery time	t_{rr}							$T_j=150^{\circ}C$	117	
Reverse recovered charge	Q_{rr}							$T_j=25^{\circ}C$	107	
Peak rate of fall of recovery current	$di(rec)max/dt$							$T_j=150^{\circ}C$	140	
Reverse recovered energy	E_{rec}							$T_j=25^{\circ}C$	3,13	
Thermal resistance chip to heatsink per chip	R_{thJH}	Thermal grease thickness $\leq 50\mu m$ $\lambda = 0,61 W/mK$							1,43	K/W
Thermistor										
Rated resistance	R					$T_j=25^{\circ}C$		22000		Ω
Deviation of R100	$\Delta R/R$	R100=1486 Ω				$T_j=100^{\circ}C$	-5		+5	%
Power dissipation	P					$T_j=25^{\circ}C$		210		mW
B-value	$B_{(25/100)}$	Tol. $\pm 3\%$				$T_j=25^{\circ}C$		4000		K
Vincotech NTC Reference									A	

Output Inverter

Figure 1 Output inverter IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

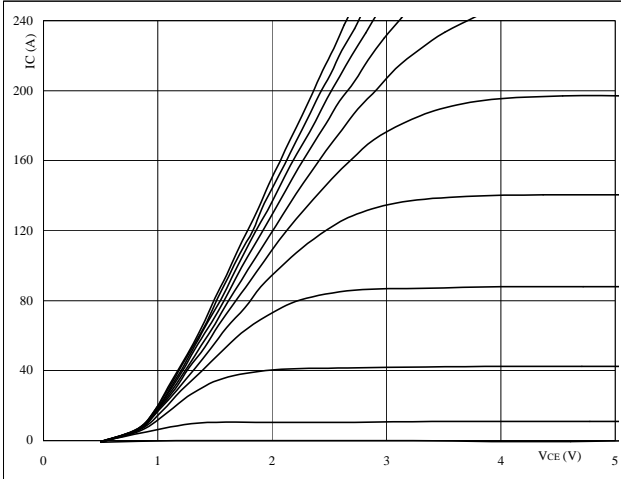

 $t_p = 250 \mu s$
 $T_j = 25 \text{ } ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

Figure 2 Output inverter IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

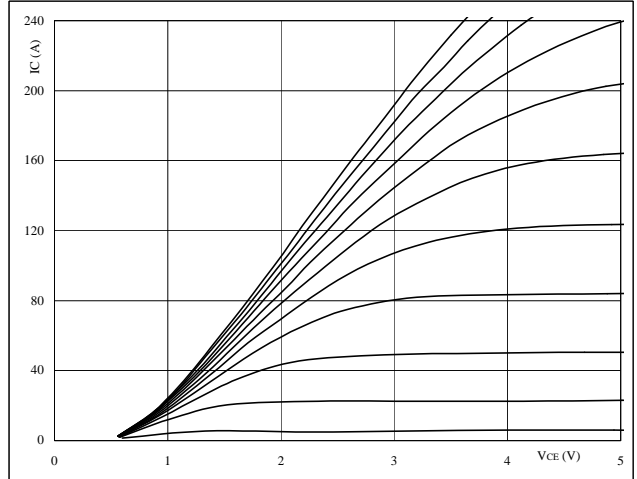
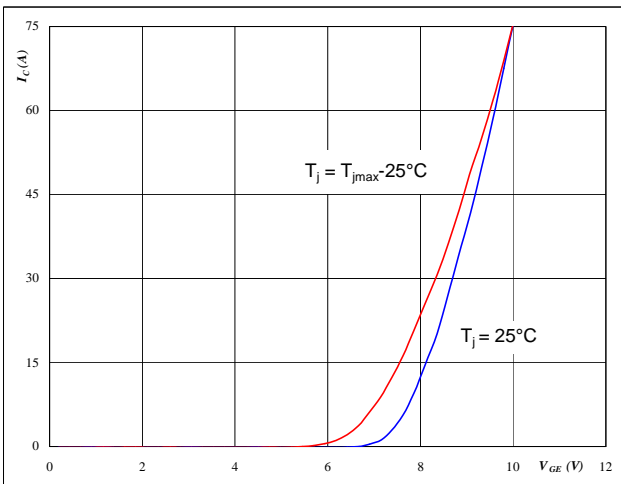

 $t_p = 250 \mu s$
 $T_j = 150 \text{ } ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

Figure 3 Output inverter IGBT

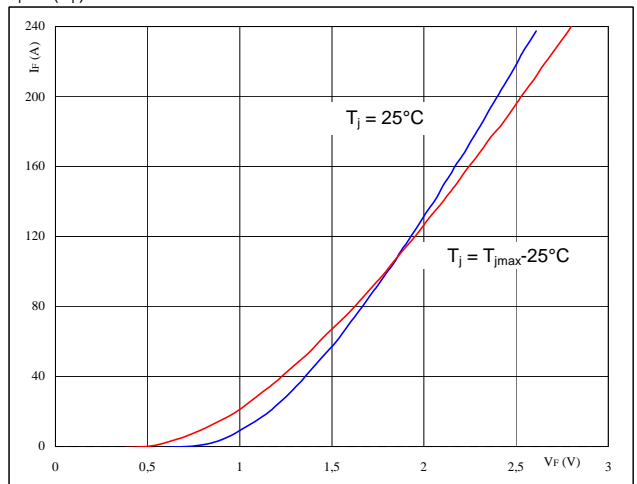
Typical transfer characteristics

$$I_C = f(V_{GE})$$


 $t_p = 250 \mu s$
 $V_{CE} = 10 \text{ V}$
Figure 4 Output inverter FWD

Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$

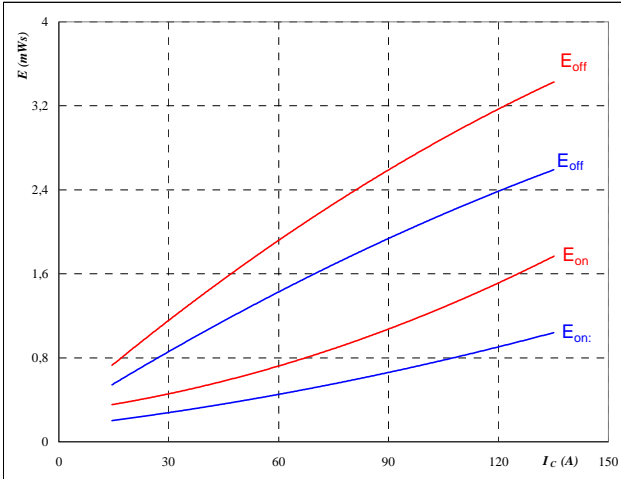

 $t_p = 250 \mu s$

Output Inverter

Figure 5 Output inverter IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$



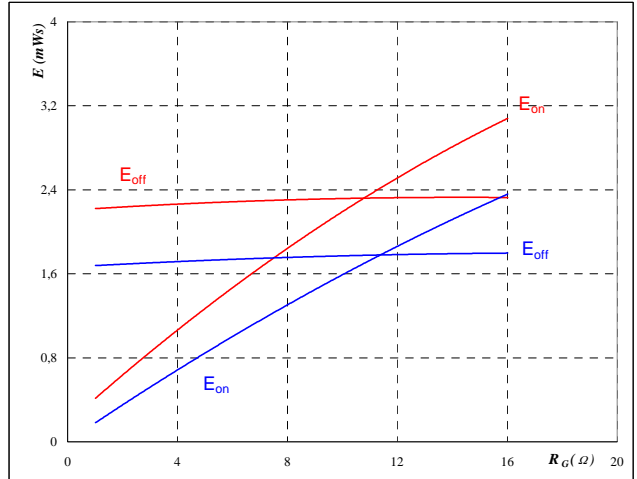
inductive load

$T_J =$	25/150	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$R_{gon} =$	4	Ω
$R_{goff} =$	4	Ω

Figure 6 Output inverter IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_G)$$



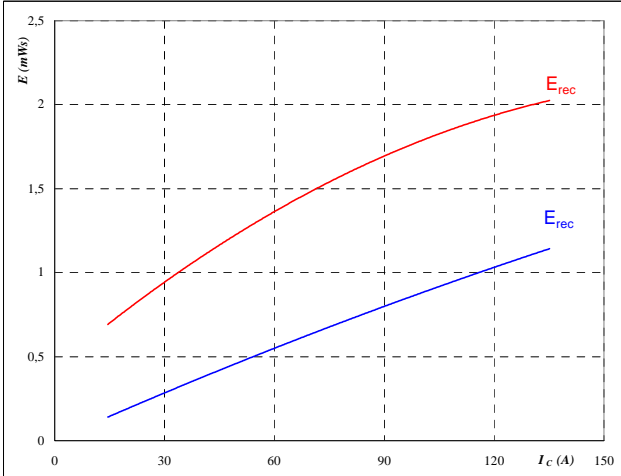
inductive load

$T_J =$	25/150	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$I_C =$	75	A

Figure 7 Output inverter IGBT

Typical reverse recovery energy loss as a function of collector current

$$E_{rec} = f(I_C)$$



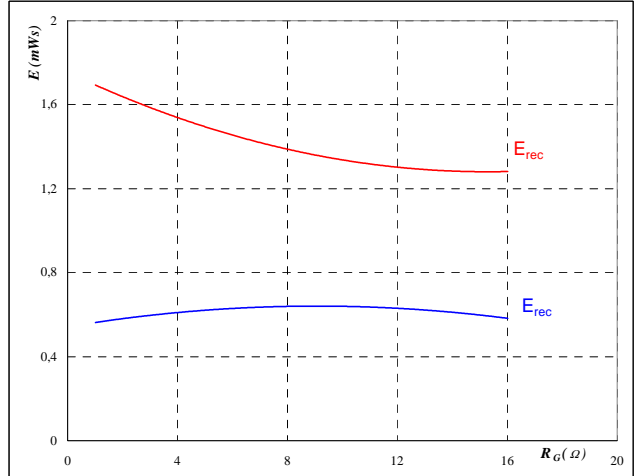
inductive load

$T_J =$	25/150	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$R_{gon} =$	4	Ω

Figure 8 Output inverter IGBT

Typical reverse recovery energy loss as a function of gate resistor

$$E_{rec} = f(R_G)$$



inductive load

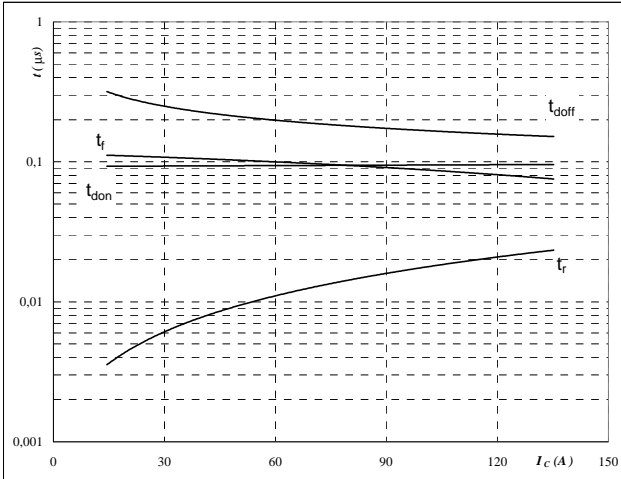
$T_J =$	25/150	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$I_C =$	75	A

Output Inverter

Figure 9 Output inverter IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



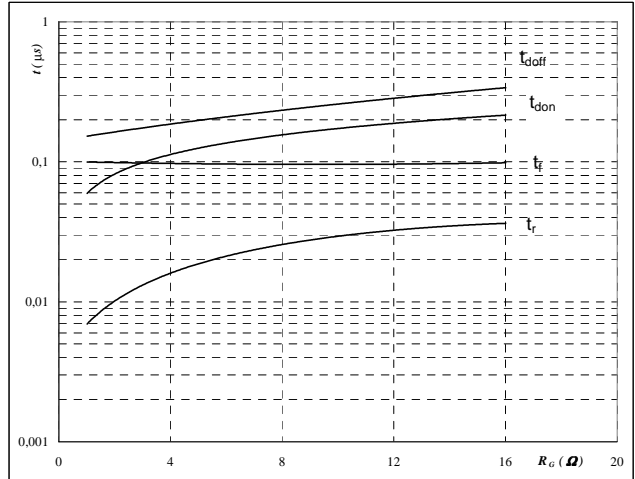
inductive load

$T_J =$	150	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$R_{gon} =$	4	Ω
$R_{goff} =$	4	Ω

Figure 10 Output inverter IGBT

Typical switching times as a function of gate resistor

$$t = f(R_G)$$



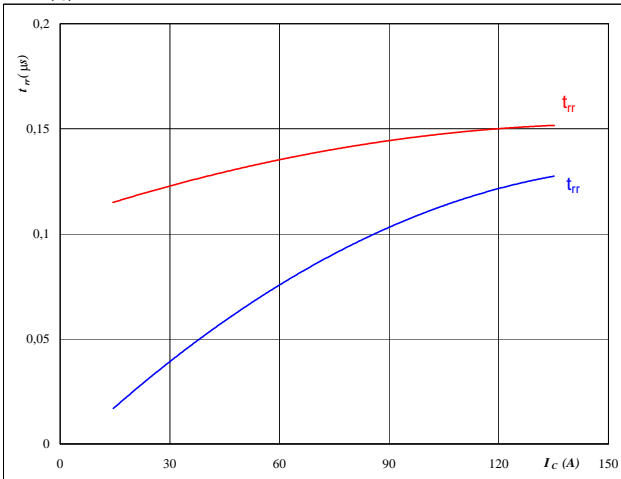
inductive load

$T_J =$	150	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$I_C =$	75	A

Figure 11 Output inverter FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$

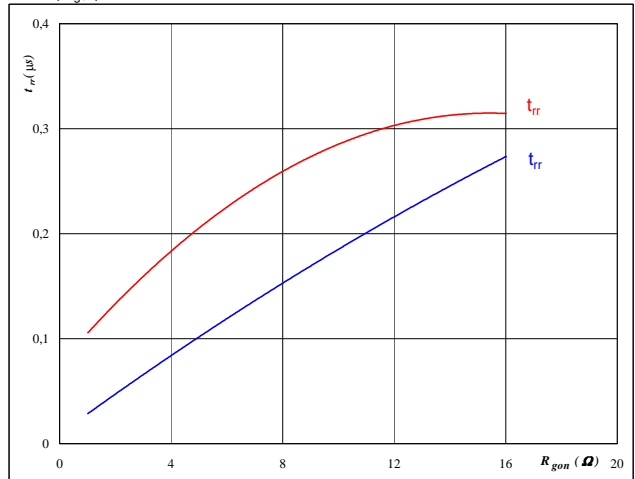


$T_J =$	25/150	°C
$V_{CE} =$	300	V
$V_{GE} =$	±15	V
$R_{gon} =$	4	Ω

Figure 12 Output inverter FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



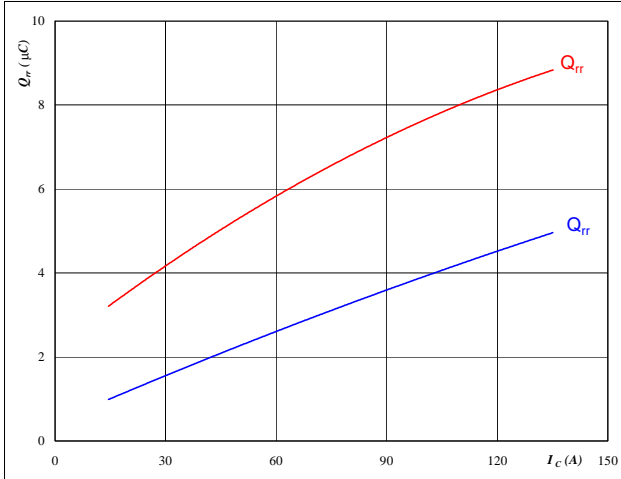
$T_J =$	25/150	°C
$V_R =$	300	V
$I_F =$	75	A
$V_{GE} =$	±15	V

Output Inverter

Figure 13 Output inverter FWD

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_C)$$

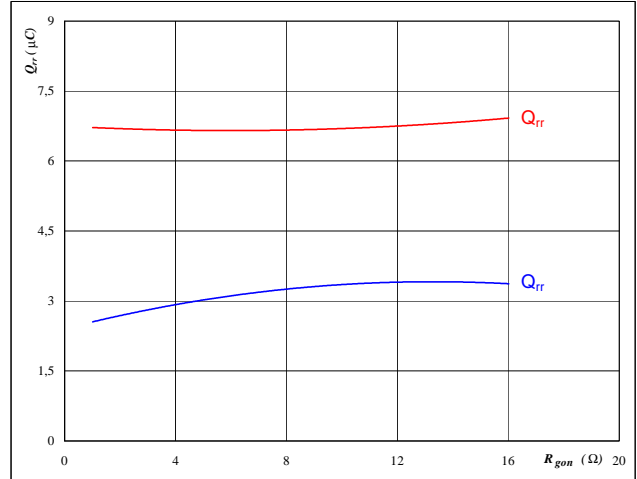


$T_j = 25/150$ °C
 $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω

Figure 14 Output inverter FWD

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{gon})$$

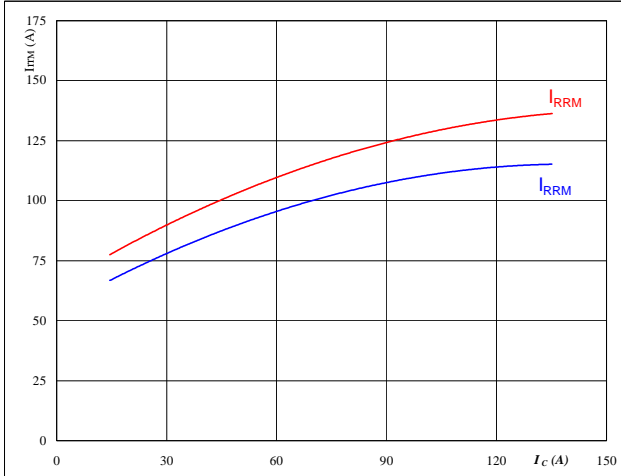


$T_j = 25/150$ °C
 $V_R = 300$ V
 $I_F = 75$ A
 $V_{GE} = \pm 15$ V

Figure 15 Output inverter FWD

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_C)$$

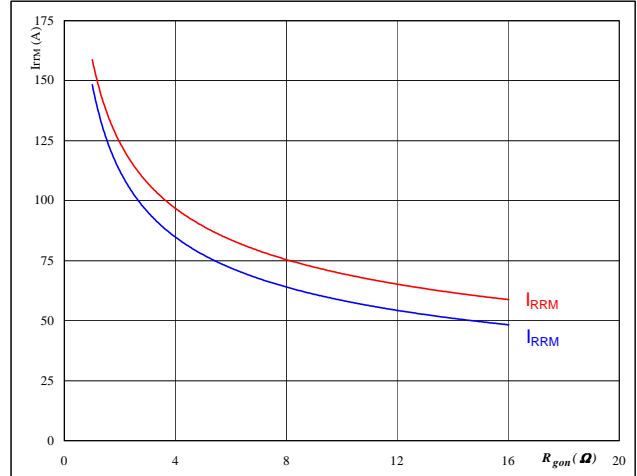


$T_j = 25/150$ °C
 $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω

Figure 16 Output inverter FWD

Typical reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RRM} = f(R_{gon})$$



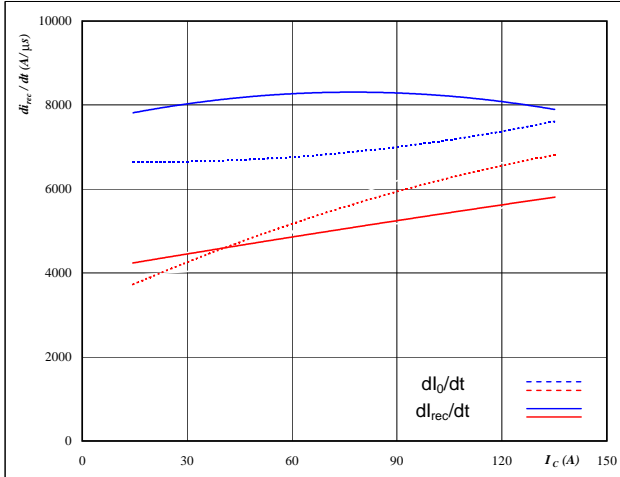
$T_j = 25/150$ °C
 $V_R = 300$ V
 $I_F = 75$ A
 $V_{GE} = \pm 15$ V

Output Inverter

Figure 17 Output inverter FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current

$$di_o/dt, di_{rec}/dt = f(I_C)$$

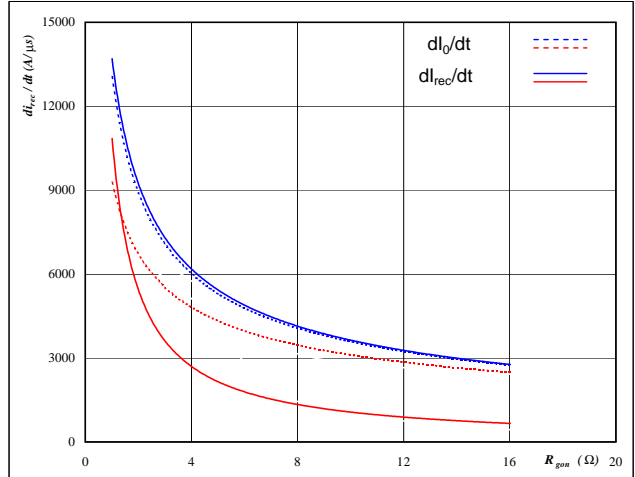


$T_j = 25/150$ °C
 $V_{CE} = 300$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω

Figure 18 Output inverter FWD

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$$di_o/dt, di_{rec}/dt = f(R_{gon})$$

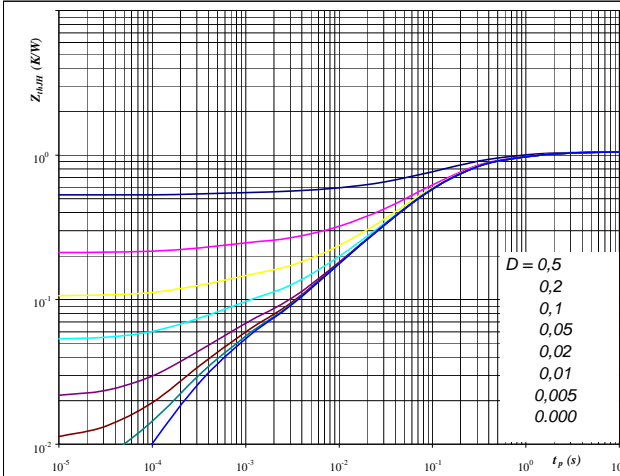


$T_j = 25/150$ °C
 $V_R = 300$ V
 $I_F = 75$ A
 $V_{GE} = \pm 15$ V

Figure 19 Output inverter IGBT

IGBT transient thermal impedance as a function of pulse width

$$Z_{thJH} = f(t_p)$$



$D = t_p / T$
 $R_{thJH} = 1,06$ K/W

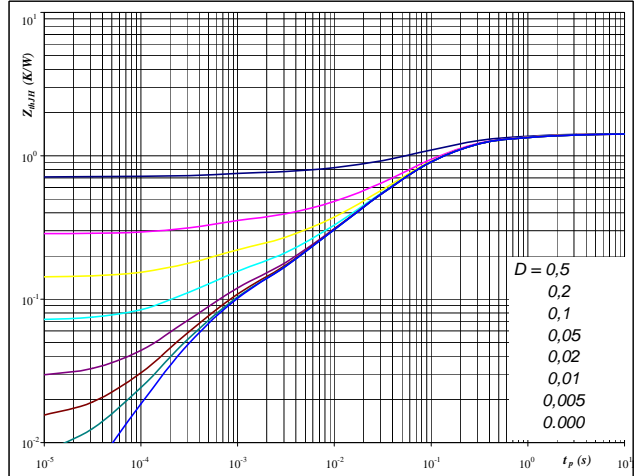
IGBT thermal model values

R (C/W)	Tau (s)
0,02	9,5E+00
0,15	1,1E+00
0,53	1,7E-01
0,24	4,1E-02
0,07	6,9E-03
0,04	4,2E-04

Figure 20 Output inverter FWD

FWD transient thermal impedance as a function of pulse width

$$Z_{thJH} = f(t_p)$$



$D = t_p / T$
 $R_{thJH} = 1,43$ K/W

FWD thermal model values

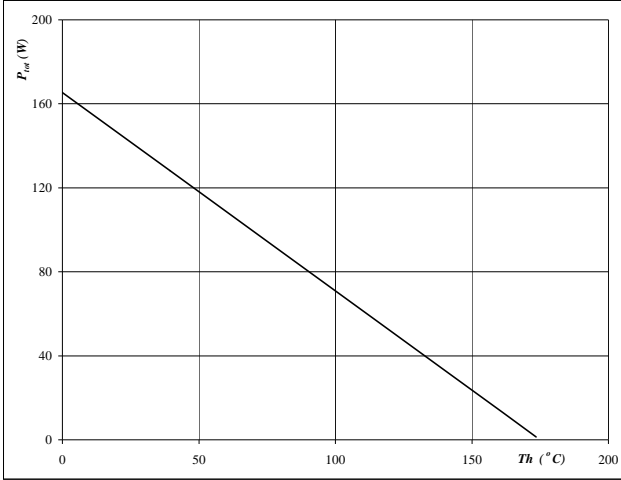
R (C/W)	Tau (s)
0,03	9,1E+00
0,16	1,0E+00
0,63	1,5E-01
0,41	4,0E-02
0,12	6,7E-03
0,08	4,6E-04

Output Inverter

Figure 21 Output inverter IGBT

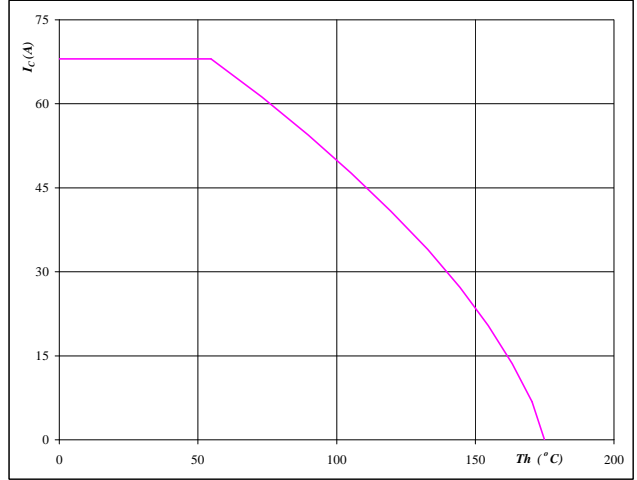
Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_h)$$


 $T_j = 175 \text{ } ^\circ\text{C}$
Figure 22 Output inverter IGBT

Collector current as a function of heatsink temperature

$$I_C = f(T_h)$$


 $T_j = 175 \text{ } ^\circ\text{C}$
 $V_{GE} = 15 \text{ V}$
Figure 23 Output inverter FWD

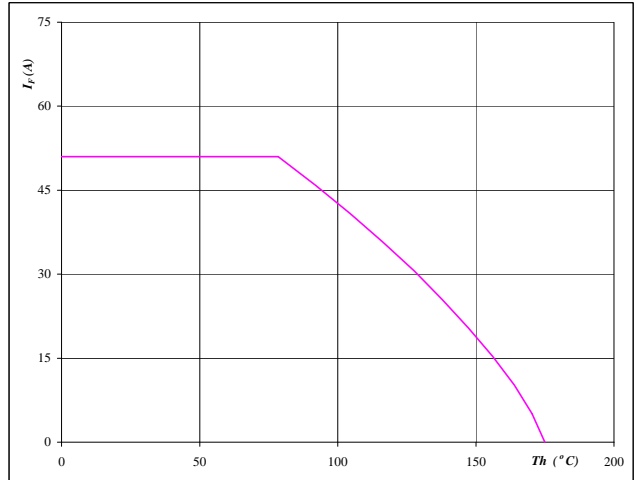
Power dissipation as a function of heatsink temperature

$$P_{tot} = f(T_h)$$


 $T_j = 175 \text{ } ^\circ\text{C}$
Figure 24 Output inverter FWD

Forward current as a function of heatsink temperature

$$I_F = f(T_h)$$

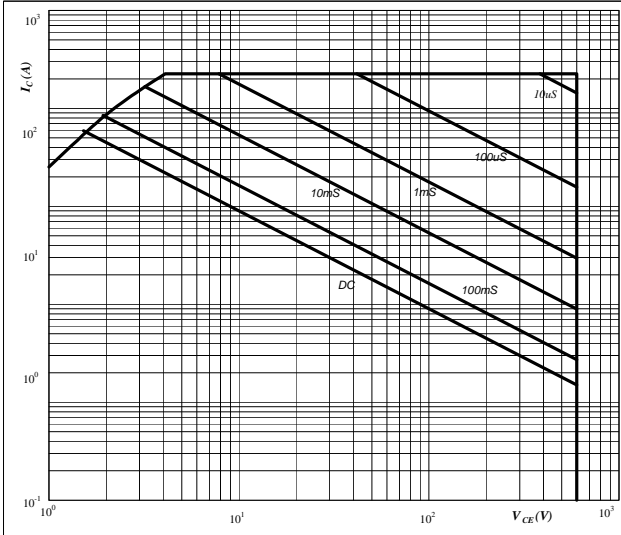

 $T_j = 175 \text{ } ^\circ\text{C}$

Output Inverter

Figure 25 Output inverter IGBT

Safe operating area as a function of collector-emitter voltage

$$I_C = f(V_{CE})$$

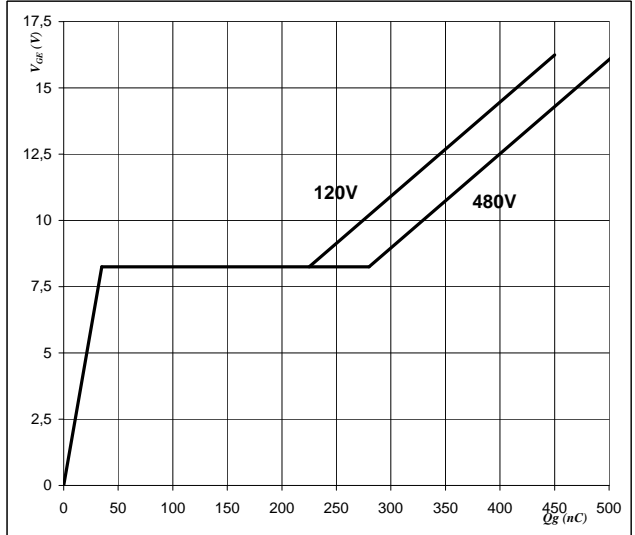


$D =$ single pulse
 $T_h =$ 80 °C
 $V_{GE} =$ ±15 V
 $T_j =$ T_{jmax} °C

Figure 26 Output inverter IGBT

Gate voltage vs Gate charge

$$V_{GE} = f(Q_g)$$



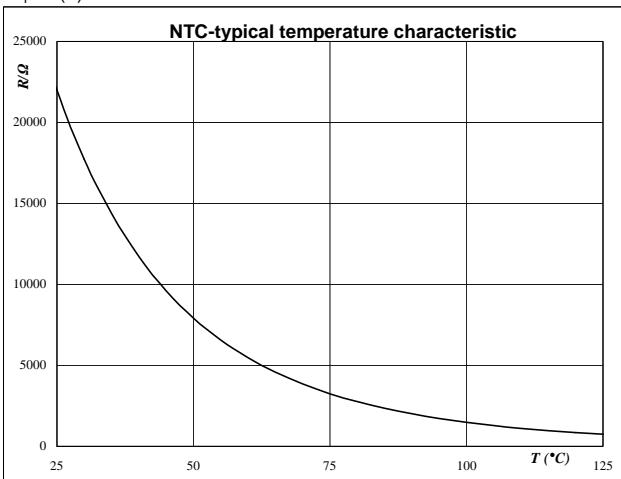
$I_C =$ 75 A

Thermistor

Figure 1 Thermistor

Typical NTC characteristic as a function of temperature

$$R_T = f(T)$$

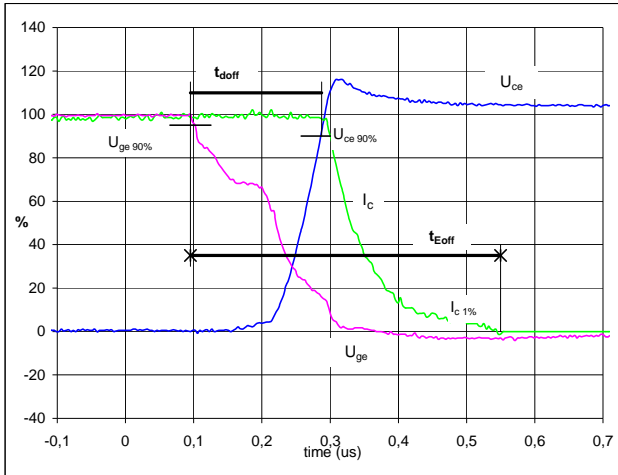


Switching Definitions Output Inverter

General conditions

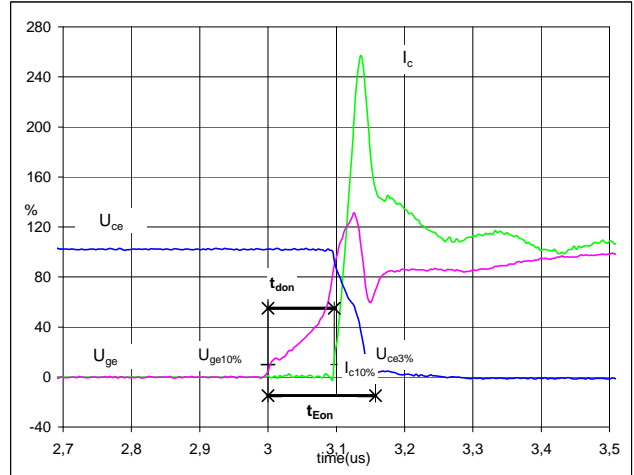
T_j	=	150 °C
R_{gon}	=	4 Ω
R_{goff}	=	4 Ω

Figure 1 Output inverter IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff}
 (t_{Eoff} = integrating time for E_{off})


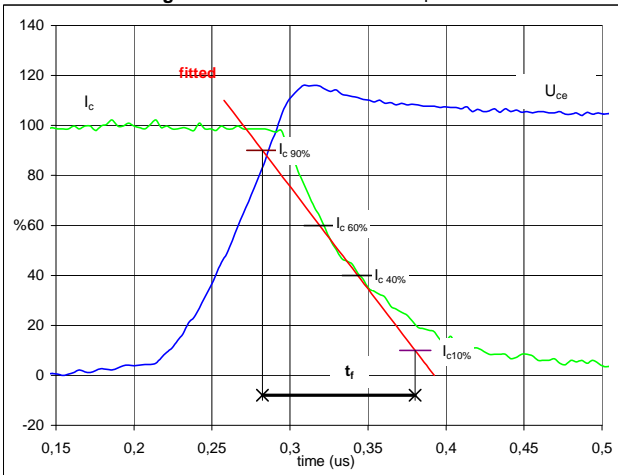
V_{GE} (0%) =	-15	V
V_{GE} (100%) =	15	V
V_C (100%) =	300	V
I_C (100%) =	75	A
t_{doff} =	0,18	μ s
t_{Eoff} =	0,45	μ s

Figure 2 Output inverter IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon}
 (t_{Eon} = integrating time for E_{on})


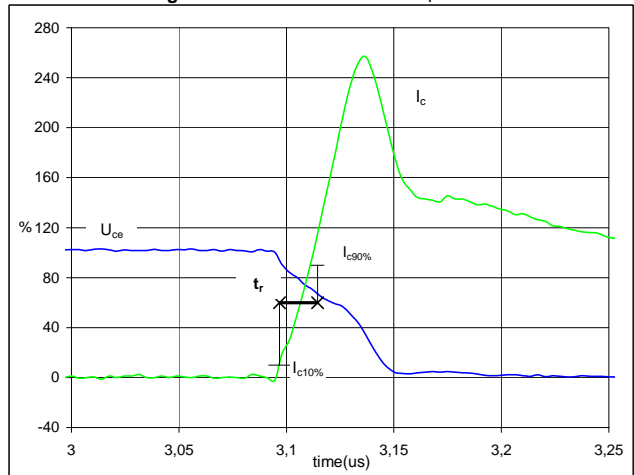
V_{GE} (0%) =	-15	V
V_{GE} (100%) =	15	V
V_C (100%) =	300	V
I_C (100%) =	75	A
t_{don} =	0,09	μ s
t_{Eon} =	0,16	μ s

Figure 3 Output inverter IGBT

Turn-off Switching Waveforms & definition of t_f


V_C (100%) =	300	V
I_C (100%) =	75	A
t_f =	0,10	μ s

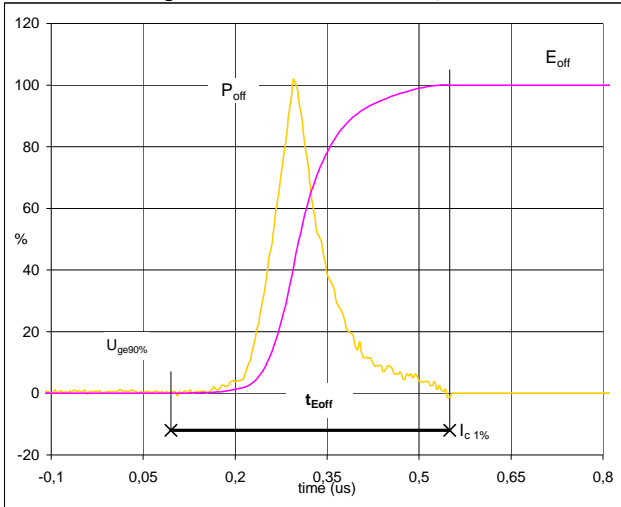
Figure 4 Output inverter IGBT

Turn-on Switching Waveforms & definition of t_r


V_C (100%) =	300	V
I_C (100%) =	75	A
t_r =	0,02	μ s

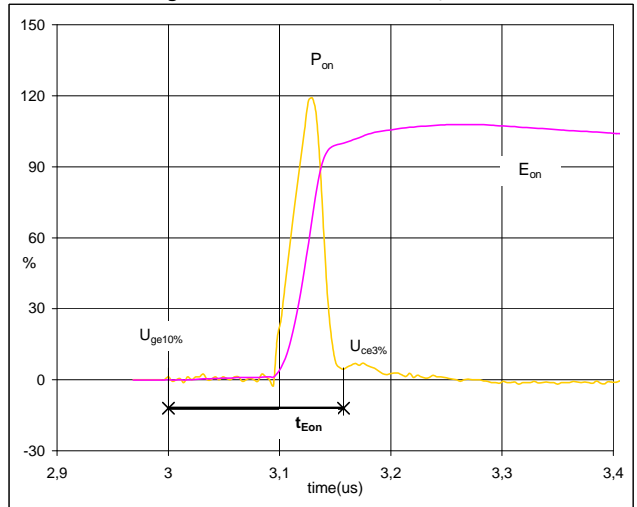
Switching Definitions Output Inverter

Figure 5 Output inverter IGBT

Turn-off Switching Waveforms & definition of t_{Eoff}


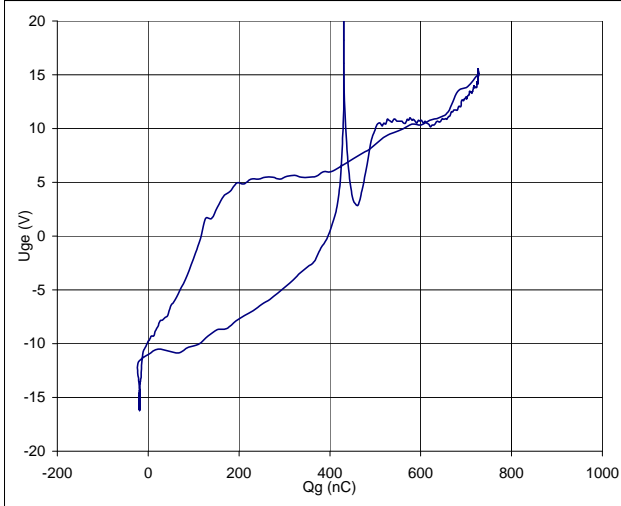
$P_{off} (100\%) =$	22,56	kW
$E_{off} (100\%) =$	2,26	mJ
$t_{Eoff} =$	0,45	μ s

Figure 6 Output inverter IGBT

Turn-on Switching Waveforms & definition of t_{Eon}


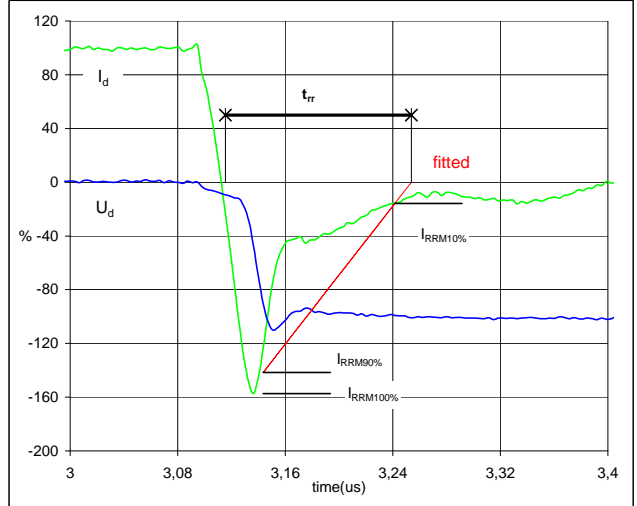
$P_{on} (100\%) =$	22,56	kW
$E_{on} (100\%) =$	0,90	mJ
$t_{Eon} =$	0,16	μ s

Figure 7 Output inverter FWD

Gate voltage vs Gate charge (measured)


$V_{GEoff} =$	-15	V
$V_{GEon} =$	15	V
$V_C (100\%) =$	300	V
$I_C (100\%) =$	75	A
$Q_g =$	4441	nC

Figure 8 Output inverter IGBT

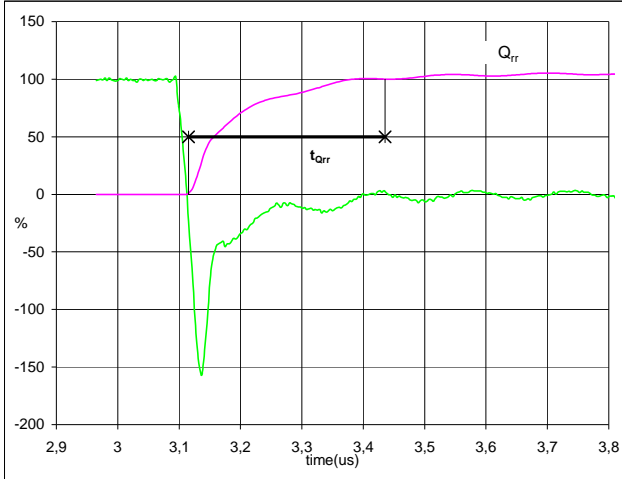
Turn-off Switching Waveforms & definition of t_{rr}


$V_d (100\%) =$	300	V
$I_d (100\%) =$	75	A
$I_{RRM} (100\%) =$	-117	A
$t_{rr} =$	0,14	μ s

Switching Definitions Output Inverter

Figure 9 Output inverter FWD

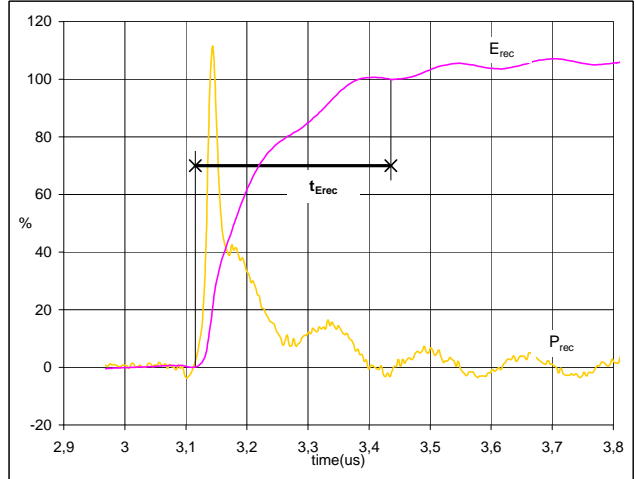
Turn-on Switching Waveforms & definition of t_{Qrr}
 (t_{Qrr} = integrating time for Q_{rr})



I_d (100%) =	75	A
Q_{rr} (100%) =	6,46	μC
t_{Qrr} =	0,32	μs

Figure 10 Output inverter FWD

Turn-on Switching Waveforms & definition of t_{Erec}
 (t_{Erec} = integrating time for E_{rec})



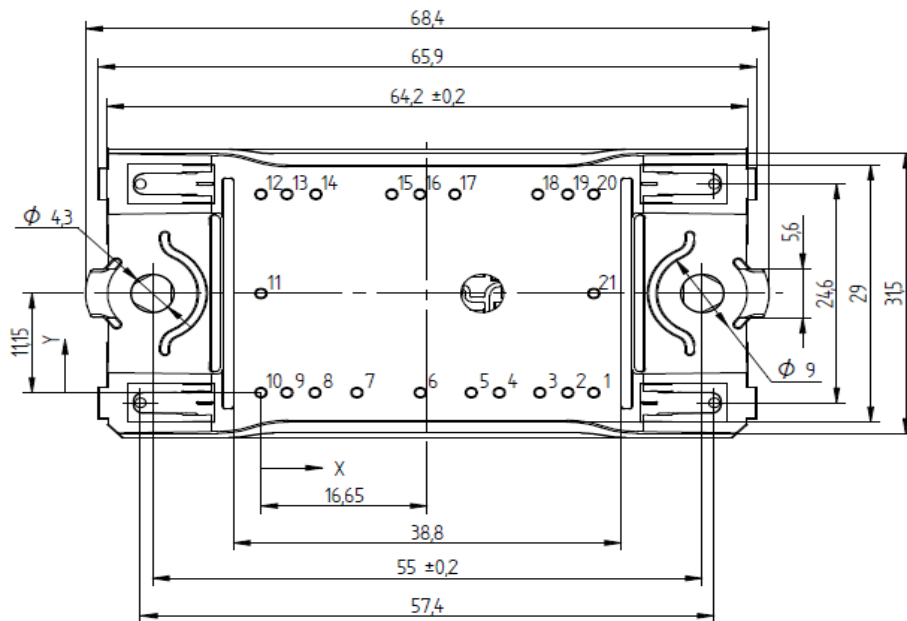
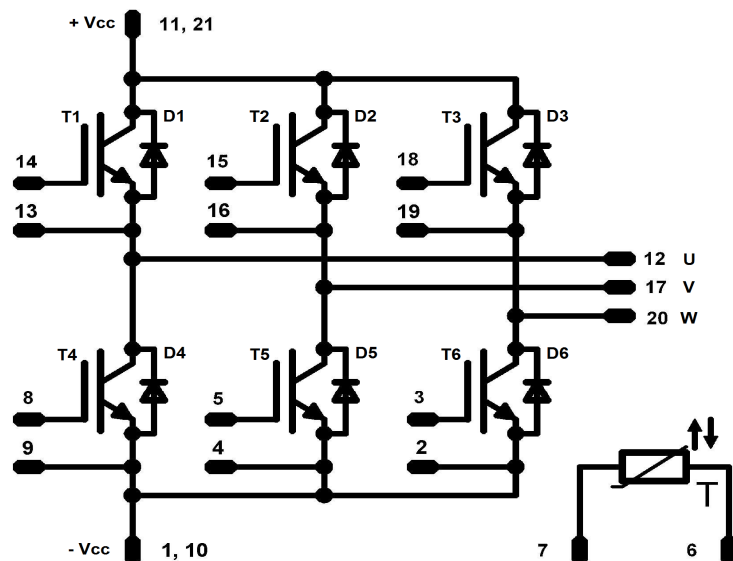
P_{rec} (100%) =	22,56	kW
E_{rec} (100%) =	1,51	mJ
t_{Erec} =	0,32	μs

Ordering Code and Marking - Outline - Pinout
Ordering Code & Marking

Version	Ordering Code	in DataMatrix as	in packaging barcode as
without thermal paste 12mm housing	V23990-P866-F48-PM	P866-F48	P866-F48
without thermal paste 17mm housing	V23990-P866-F49-PM	P866-F49	P866-F49

Outline

Pin table		
Pin	X	Y
1	33,3	0
2	30,7	0
3	27,9	0
4	23,85	0
5	21,05	0
6	15,95	0
7	9,6	0
8	5,4	0
9	2,6	0
10	0	0
11	0	11,15
12	0	22,3
13	2,6	22,3
14	5,5	22,3
15	13,1	22,3
16	15,9	22,3
17	19,4	22,3
18	27,7	22,3
19	30,7	22,3
20	33,3	22,3
21	33,3	11,15


Pinout


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